

## **RQJ0201UGDQA**

# Silicon P Channel MOS FET Power Switching

REJ03G1317-0300 Rev.3.00 May 24, 2006

#### **Features**

- Low on-resistance  $R_{DS(on)} = 53 \text{ m}\Omega \text{ typ } (V_{GS} = -4.5 \text{ V}, I_D = -1.8 \text{ A})$
- Low drive current
- High speed switching
- 2.5 V gate drive

#### **Outline**

RENESAS Package code: PLSP0003ZB-A (Package name: MPAK)

3
0
1. Source
2. Gate
3. Drain

Note: Marking is "UG".

#### **Absolute Maximum Ratings**

 $(Ta = 25^{\circ}C)$ 

			( /
Item	Symbol	Ratings	Unit
Drain to source voltage	V <sub>DSS</sub>	-20	V
Gate to source voltage	V <sub>GSS</sub>	+8 / -12	V
Drain current	I <sub>D</sub>	-3.4	Α
Drain peak current	I <sub>D(pulse)</sub> Note1	-10	Α
Body - drain diode reverse drain current	I <sub>DR</sub>	-3.4	Α
Channel dissipation	Pch <sub>(pulse)</sub> Note2	0.8	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW  $\leq$  10  $\mu$ s, duty cycle  $\leq$  1%

2. When using the glass epoxy board (FR-4: 40 x 40 x 1 mm)

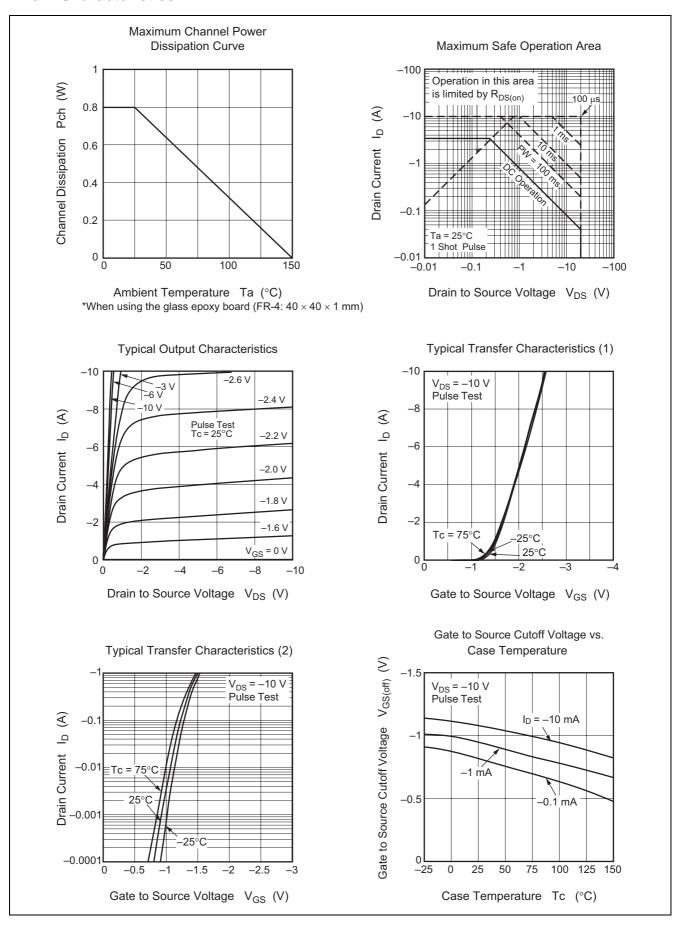
#### **Electrical Characteristics**

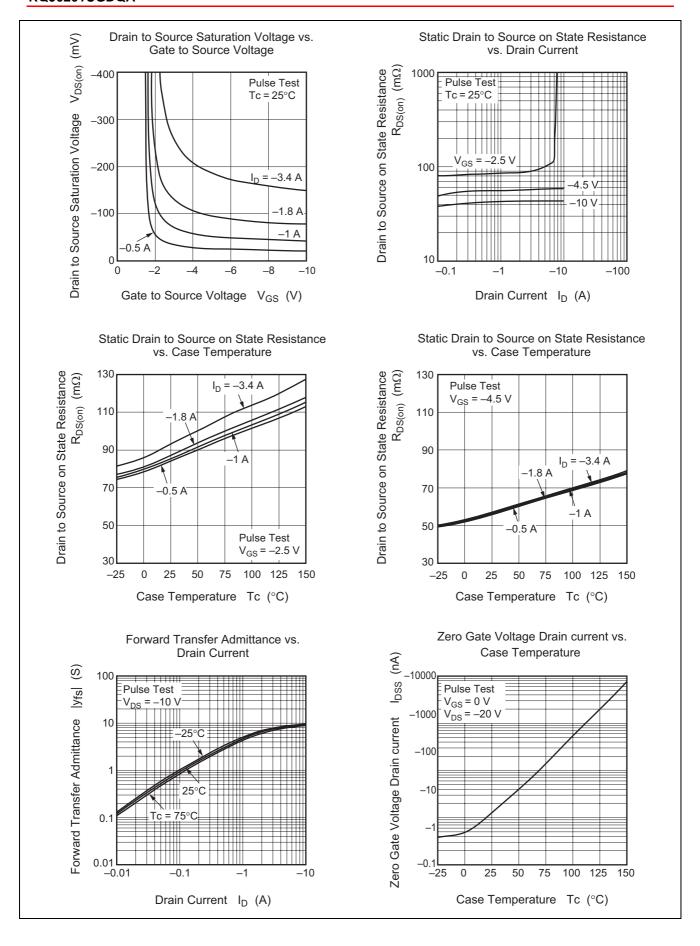
 $(Ta = 25^{\circ}C)$ 

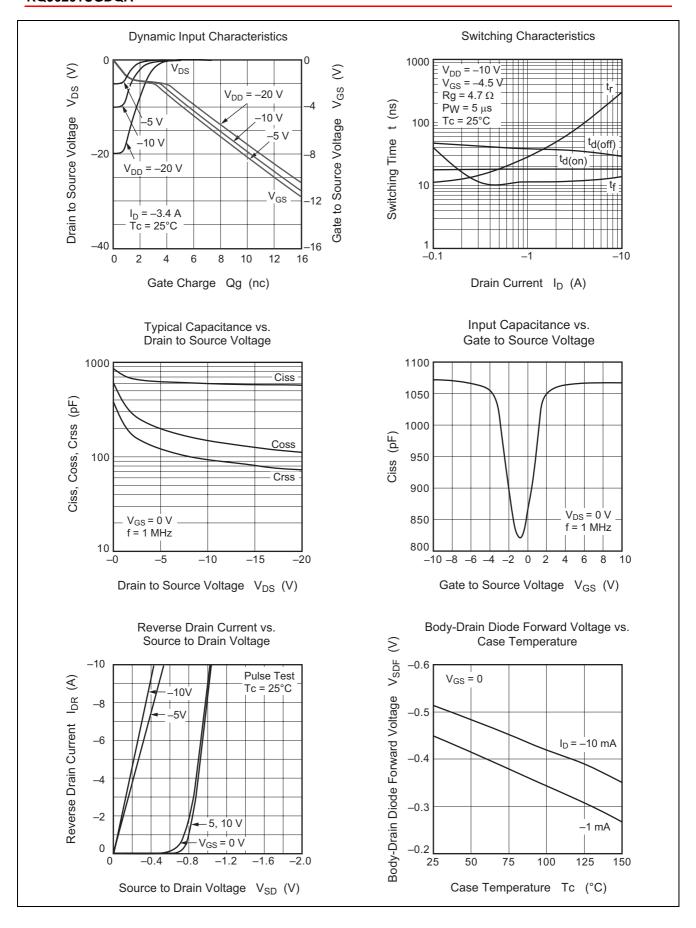
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	-20	_	_	V	$I_D = -10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	+8	_	_	V	$I_G = +100 \mu\text{A},  V_{DS} = 0$
	V <sub>(BR)GSS</sub>	-12	_	_	V	$I_G = -100 \mu\text{A},  V_{DS} = 0$
Gate to source leak current	I <sub>GSS</sub>		_	+10	μΑ	$V_{GS} = +6 \text{ V}, V_{DS} = 0$
	I <sub>GSS</sub>	_	_	-10	μΑ	$V_{GS} = -10 \text{ V}, V_{DS} = 0$
Drain to source leak current	I <sub>DSS</sub>	_	_	-1	μΑ	$V_{DS} = -20 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	-0.4	_	-1.4	V	$V_{DS} = -10 \text{ V}, I_{D} = -1 \text{ mA}$
Drain to source on state resistance	R <sub>DS(on)</sub>	_	53	69	mΩ	$I_D = -1.8 \text{ A}, V_{GS} = -4.5 \text{ V}^{\text{Note3}}$
	R <sub>DS(on)</sub>	_	80	112	mΩ	$I_D = -1.8 \text{ A}, V_{GS} = -2.5 \text{ V}^{\text{Note3}}$
Forward transfer admittance	y <sub>fs</sub>	4.5	6.5	_	S	$I_D = -1.8 \text{ A}, V_{DS} = -10 \text{ V}^{\text{Note3}}$
Input capacitance	Ciss	_	597	_	pF	V <sub>DS</sub> = -10 V
Output capacitance	Coss	_	149	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	93	_	pF	f = 1 MHz
Turn - on delay time	t <sub>d(on)</sub>	_	18	_	ns	$I_D = -1.8 \text{ A}$
Rise time	t <sub>r</sub>	_	43	_	ns	$V_{GS} = -4.5 \text{ V}$
Turn - off delay time	$t_{d(off)}$	_	37	_	ns	$R_L = 5.5 \Omega$
Fall time	t <sub>f</sub>	_	12	_	ns	$Rg = 4.7 \Omega$
Total gate charge	Qg		6.3		nC	V <sub>DD</sub> = -10 V
Gate to source charge	Qgs		1.1		nC	$V_{GS} = -4.5 \text{ V}$
Gate to drain charge	Qgd	_	2.5	_	nC	$I_D = -3.4 \text{ A}$
Body - drain diode forward voltage	$V_{DF}$	_	-0.85	-1.1	V	$I_F = -3.4 \text{ A}, V_{GS} = 0^{\text{Note3}}$

Notes: 3. Pulse test

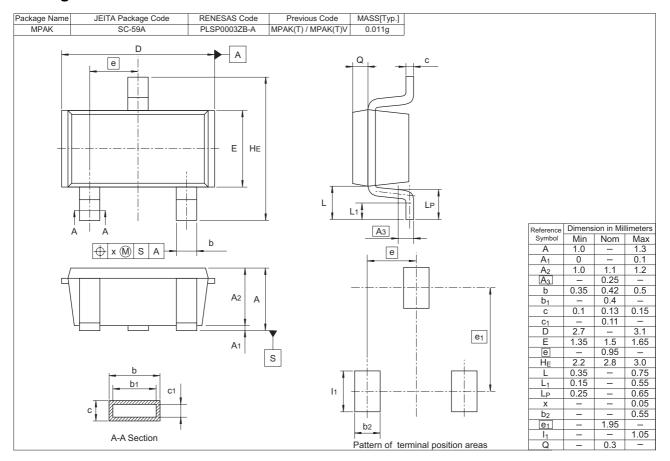
#### **Main Characteristics**







#### **Package Dimensions**



### **Ordering Information**

Part Name	Quantity	Shipping Container
RQJ0201UGDQATL-E	3000 pcs.	φ178 mm reel, 8 mm Emboss taping

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**Renesas Technology America, Inc.** 450 Holger Way, San Jose, CA 95134-1368, U.S.A Tel: <1> (408) 382-7500, Fax: <1> (408) 382-7501

Renesas Technology Europe Limited
Dukes Meadow, Millboard Road, Bourne End, Buckinghamshire, SL8 5FH, U.K.
Tel: <44> (1628) 585-100, Fax: <44> (1628) 585-900

Renesas Technology (Shanghai) Co., Ltd.

Neitesas Technology (offangriar) 63., Ed. Unit 204, 205, AZIACenter, No. 1233 Lujiazui Ring Rd, Pudong District, Shanghai, China 200120 Tel: <86> (21) 5877-1818, Fax: <86> (21) 6887-7898

Renesas Technology Hong Kong Ltd.
7th Floor, North Tower, World Finance Centre, Harbour City, 1 Canton Road, Tsimshatsui, Kowloon, Hong Kong Tel: <852> 2265-6688, Fax: <852> 2730-6071

**Renesas Technology Taiwan Co., Ltd.**10th Floor, No.99, Fushing North Road, Taipei, Taiwan Tel: <886> (2) 2715-2888, Fax: <886> (2) 2713-2999

Renesas Technology Singapore Pte. Ltd.
1 Harbour Front Avenue, #06-10, Keppel Bay Tower, Singapore 098632 Tel: <65> 6213-0200, Fax: <65> 6278-8001

Renesas Technology Korea Co., Ltd. Kukje Center Bldg. 18th Fl., 191, 2-ka, Hangang-ro, Yongsan-ku, Seoul 140-702, Korea Tel: <82> (2) 796-3115, Fax: <82> (2) 796-2145

Renesas Technology Malaysia Sdn. Bhd
Unit 906, Block B, Menara Amcorp, Amcorp Trade Centre, No.18, Jalan Persiaran Barat, 46050 Petaling Jaya, Selangor Darul Ehsan, Malaysia Tel: <603> 7955-9390, Fax: <603> 7955-9510

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